IGBT Module

STARPOWER

SEMICONDUCTOR

GD75FFT60F1S

600V/75A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

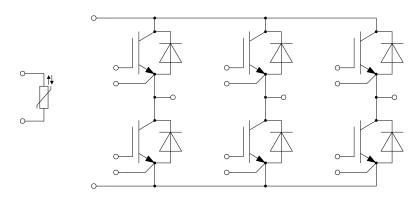
Features

- Low V_{CE(sat)} Trench IGBT technology
- Low switching loss
- 5µs short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Fast & soft reverse recovery anti-parallel FWD
- Isolated heatsink using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



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Preliminary



IGBT

Absolute Maximum Ratings T_C=25°C unless otherwise noted

IGBT-inverter

Symbol	Description	Value	Unit	
V _{CES}	Collector-Emitter Voltage	600	V	
V _{GES}	Gate-Emitter Voltage	±20	V	
I _C	Collector Current @ $T_c=25^{\circ}C$	89	•	
	a T _C =55°C	75	A	
I _{CM}	Pulsed Collector Current t _p =1ms	150	Α	
P _D	Maximum Power Dissipation @ T _i =175°C	248	W	

Diode-inverter

Symbol	Description	Value	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	600	V
I _F	Diode Continuous Forward Current	75	Α
I _{FM}	Diode Maximum Forward Current t _p =1ms	150	Α

Module

Symbol	Description	Value	Unit
T _{jmax}	Maximum Junction Temperature	175	°C
T _{jop}	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature Range	-40 to +125	°C
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	4000	V

GD75FFT60F1S

IGBT-inverter Characteristics $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
		$I_{C}=75A, V_{GE}=15V, T_{i}=25^{\circ}C$		1.70	2.15	
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C}=75A, V_{GE}=15V, T_{i}=125^{\circ}C$		1.95		V
		$I_{C}=75A, V_{GE}=15V, T_{i}=150^{\circ}C$		2.00		
V _{GE(th)}	Gate-Emitter Threshold Voltage	$I_C=2.1$ mA, $V_{CE}=V_{GE}$, $T_i=25^{\circ}$ C	4.0	4.5	6.5	V
I _{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0V,$ $T_j=25^{\circ}C$			1.0	mA
I _{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V,$ $T_j=25^{\circ}C$			400	nA
R _{Gint}	Internal Gate Resistance			/		Ω
C _{ies}	Input Capacitance	V _{CE} =30V,f=1MHz,		4.44		nF
C _{res}	Reverse Transfer Capacitance	V _{GE} =0V		0.13		nF
Q _G	Gate Charge	$V_{GE}=15V$		0.15		μC
t _{d(on)}	Turn-On Delay Time	-		105		ns
t _r	Rise Time			54		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC}=300V,I_{C}=75A,$		104		ns
t _f	Fall Time	$R_{G} = 8.2\Omega, V_{GE} = \pm 15V,$		76		ns
Eon	Turn-On Switching Loss	$R_{G}=8.202, V_{GE}=\pm15 V,$ $T_{j}=25^{\circ}C$		0.65		mJ
E _{off}	Turn-Off Switching Loss			0.82		mJ
t _{d(on)}	Turn-On Delay Time			105		ns
t _r	Rise Time			54		ns
t _{d(off)}	Turn-Off Delay Time	N -200NI -75 A		109		ns
t _f	Fall Time	$V_{CC}=300V,I_{C}=75A,$		100		ns
Eon	Turn-On Switching Loss	$R_{G}=8.2\Omega, V_{GE}=\pm 15V, T_{j}=125^{\circ}C$		0.75		mJ
E _{off}	Turn-Off Switching Loss			1.09		mJ
t _{d(on)}	Turn-On Delay Time			105		ns
t _r	Rise Time			55		ns
t _{d(off)}	Turn-Off Delay Time	N -200NI -75 A		112		ns
t _f	Fall Time	$V_{CC}=300V,I_{C}=75A,$		108		ns
E _{on}	Turn-On Switching Loss	$R_{G}=8.2\Omega, V_{GE}=\pm 15V, T_{j}=150^{\circ}C$		0.83		mJ
E _{off}	Turn-Off Switching Loss			1.28		mJ
I _{SC}	SC Data	$\begin{array}{l} t_{P} \leq 5 \mu s, V_{GE} = 15 V, \\ T_{j} = 150^{\circ} C, V_{CC} = 360 V, \\ V_{CEM} \leq 600 V \end{array}$		675		А

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{\rm F}$	Diode Forward Voltage	$I_{\rm F}$ =75A, $V_{\rm GE}$ =0V, $T_{\rm i}$ =25°C		1.55	2.00	V
		$I_{F}=75A, V_{GE}=0V, T_{j}=125^{\circ}C$		1.50		
		$I_{\rm F}$ =75A, $V_{\rm GE}$ =0V, $T_{\rm j}$ =150°C		1.50		
Qr	Recovered Charge			3.4		μC
I _{RM}	Peak Reverse	V_{R} =300V, I_{F} =75A,		53		А
I _{RM}	Recovery Current	$-di/dt=1600A/\mu s, V_{GE}=-15V$		55		A
E _{rec}	Reverse Recovery	$T_j=25^{\circ}C$		0.76		mJ
	Energy			0.70		IIIJ
Qr	Recovered Charge	V _R =300V,I _F =75A, -di/dt=1600A/µs,V _{GE} =-15V		5.7		μC
I _{RM}	Peak Reverse			66		А
IRM	Recovery Current					Α
E _{rec}	Reverse Recovery	$T_j=125^{\circ}C$		1.47		mJ
	Energy			1.47		1115
Qr	Recovered Charge			6.0		μC
I _{RM}	Peak Reverse	V_{R} =300V, I_{F} =75A,		70		А
	Recovery Current	$-di/dt=1600A/\mu s, V_{GE}=-15V$		70		А
E _{rec}	Reverse Recovery	$T_j=150^{\circ}C$		1.54		mJ
	Energy			1.34		1113

Diode-inverter Characteristics T_C=25°C unless otherwise noted

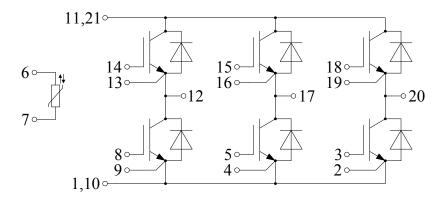
NTC Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
R ₂₅	Rated Resistance			22.0		kΩ
$\Delta R/R$	Deviation of R ₁₀₀	$T_{C}=100^{\circ}C, R_{100}=1486.1\Omega$	-5		5	%
P ₂₅	Power Dissipation				200	mW
B _{25/50}	B-value	$\begin{array}{l} R_2 = R_{25} exp[B_{25/50}(1/T_2 - 1/(298.15K))] \end{array}$		4000		K

Module Characteristics T_c=25°C unless otherwise noted

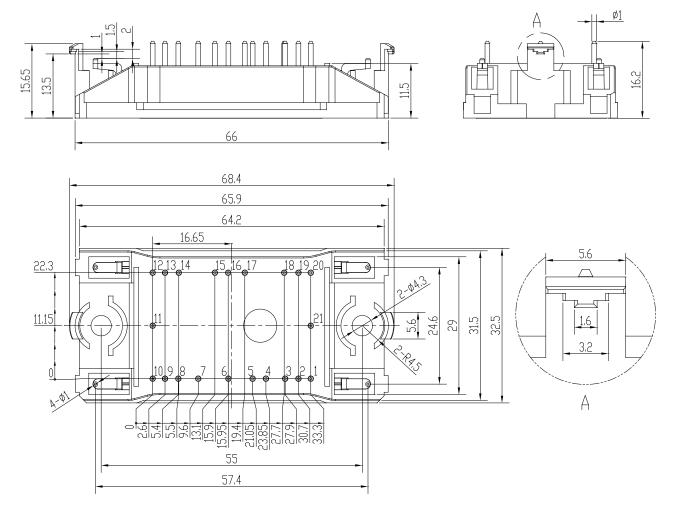
Symbol	Parameter		Тур.	Max.	Unit
R _{thJC}	Junction-to-Case (per IGBT-inverter)		0.549	0.604	K/W
	Junction-to-Case (per Diode-inverter)		0.610	0.671	K/ W
R_{thCH}	Case-to-Heatsink (per IGBT-inverter)		0.399		
	Case-to-Heatsink (per Diode-inverter)		0.443		K/W
	Case-to-Heatsink (per Module)		0.035		
М	Mounting Torque, Screw M4	2.0		2.2	N.m
G	Weight of Module		26		g

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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